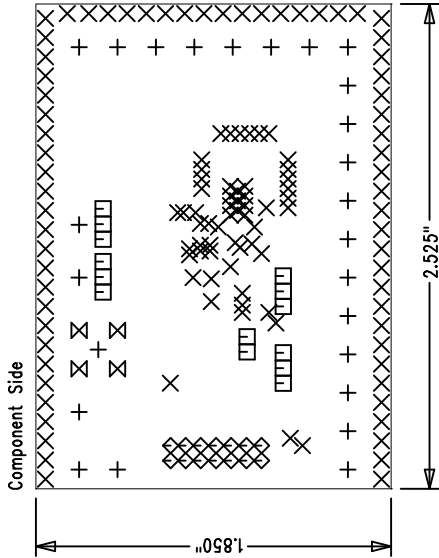


REVISIONS			
REV	DATE	APPR	DATE




- ART01 = LAYER 1 ( COMPONENT SIDE )
- ART02 = LAYER 2 (GND)
- ART03 = LAYER 3 (GND)
- ART04 = LAYER 4 (SOLDER SIDE)

### NOTES : Unless Otherwise Specified

- MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD  
THICKNESS .062 +/- .006 TOTAL OF 4 LAYERS
- FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE  
ELECTRODEPOSITED TIN-LEAD COMPOSITION  
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SM08C)
- SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT
- SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
- ALL DIMENSIONS ARE IN INCHES

## Fabrication Drawing

APPROVALS					1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408)432-1900	
			INIT	DATE		
	DRAWN					
	CHECK					
	DESIGN					
	ENGR					
Scale = None			Design #		Sht: 1 of 1	

Title:		LTC2446UHF	
24-Bit High Speed 4-/8-Channel Delta Sigma ADC			
Size:	Demo Board:	DC847A	Rev.
	None		



Title: LTC2446UHF

24-Bit High Speed 4-/8-Channel Delta Sigma ADC

Size: None

Demo Board: DC847A

Rev.